TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7WT74FU

D-Type Flip-Flop with Preset and Clear

The TC7WT74FU is high speed CMOS D-TYPE FLIP-FLOP fabricated with silicon gate CMOS technology.

It achieves the high speed operation similar to equivalent Bipolar schottky TTL while maintaining the CMOS low power dissipation.

The input threshold levels are compatible with TTL output voltage.

The signal level applied to the D-INPUT is tranceferred to Q-OUTPUT during the positive going trasition of the CK pulse.

CLEAR and PRESET are independent of the CK and are

accompished by setting the appropriate input low.

All inputs are equipped with protection circuits against static dichage or transient excess voltage.

SSOP8-P-0.65 (SM8)

Weight

TC7WT74FU

SSOP8-P-0.65: 0.02 g (typ.)

Features

- High speed: f_{MAX} = 53 MHz(typ.) at V_{CC} = 5 V
- Low power dissipation: I_{CC} = 2 μA (max) at Ta = 25°C
- Compatible with TTL inputs: V_{IL} = 0.8 V(max) at Ta=25°C
- Output drive capability: 10 LSTTL Loads
- Symmetrical output impedance: |I_{OH}| = I_{OL} = 4 mA (min)

Absolute Maximum Ratings (Ta = 25°C)

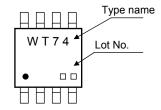
Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	−0.5 to 7	V
DC input voltage	V _{IN}	–0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	–0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±25	mA
Power dissipation	PD	300	mW
Storage temperature	T _{stg}	-65 to 150	°C
Lead temperature (10s)	TL	260	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating

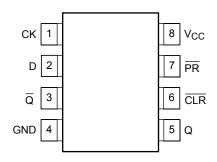
temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Marking



Pin Assignment (top view)

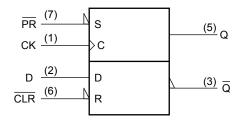


Truth Table

	Inp	uts		Outputs		Function
CLR	PR	D	CK	Q	Q	
L	Н	Х	Х	L	Н	Clear
Н	L	Х	Х	Н	L	Preset
L	L	Х	Х	Н	Н	_
Н	Н	L		L	Н	_
Н	Н	Н	<u></u>	Н	L	_
Н	Н	Х	7	Qn	Qn	No Change

X: Don't care

IEC Logic Symbol



Operating Ranges

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	4.5 to 5.5	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	t _r , t _f	0 to 500	ns

DC Electrical Characteristics

Characteristics Symbol		Symbol	Toot	Condition			Га = 25°C)	Ta = -4	0 to 85°C	Unit	
Cilarac	ici istics	Symbol	nbol Test Condition		V _{CC} (V)		Тур.	Max	Min	Max	Offic	
Input	High level	V _{IH}		_	4.5 to 5.5	2.0	_	_	2.0	_	V	
voltage	Low level	V _{IL}		_	4.5 to 5.5	_	_	0.8	_	0.8	V	
			I limb laval	V _{IN} =	$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High level Output	High level	V _{OH}	V _{IL} or V _{IH}	I _{OH} = -4 mA	4.5	4.18	4.31	_	4.13	_	V	
voltage	e V ₁	el V _{OL} VIN =	I _{OL} = 20 μA	4.5	_	0.0	0.10	_	0.10	V		
			I _{OL} = 4 mA	4.5	_	0.17	0.26	_	0.33	V		
Input leakage	current	I _{IN}	$V_{IN} = V_{CC}$	or GND	5.5	_	_	±0.1	_	±1	μΑ	
	I _{CC} V _{IN} = V _{CC} or GND		or GND	5.5	_	_	2.0	_	20.0	μΑ		
Quiescent supply current		ICCT		T: V _{IN} = 0.5 V or 2.4V PUT: V _{CC} or GND	5.5	_	_	2.0	_	2.9	mA	

Timing Requirements (Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol Test Condition			Ta = 25°C		Ta = -40 to 85°C	Unit	
Characteristics			V _{CC} (V)	Тур	LIMIT	LIMIT	Offic	
Minimum pulse width	t _W (L)		4.5	_	25	29	ns	
(CLOCK)	t _W (H)	_	5.5		20	23	115	
Minimum pulse width	t(L)		4.5	_	30	34		
(CLR, PR)	t _W (L)	W(L) —	5.5	_	25	28	ns	
Minimum set-up time	+-		4.5	_	25	29	ns	
	ts	_	5.5	_	20	23	115	
Minimum hold time	t _h —		4.5	_	10	10	ns	
Minimum noid time		5.5	_	8	8	115		
Minimum removal time (CLR, PR)			4.5	_	10	10	20	
	t _{rem} —	5.5	_	10	10	ns		
Clock frequency			4.5	_	22	16	MHz	
		f —			25	19	IVI□Z	

AC Electrical Characteristics ($C_L = 15pF$, $V_{CC} = 5V$, $Ta = 25^{\circ}C$)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH} t _{THL}	_	_	6	12	ns
Propagation delay time (CLOCK – Q, Q)	t _{PLH}	_	_	17	28	ns
Propagation delay time (CLR, PR - Q, Q)	t _{PLH}	_	_	20	30	ns
Maximum clock frequency	f _{MAX}	_	24	53	_	MHz

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AC Electrical Characteristics ($C_L = 50pF$, Input $t_r = t_f = 6 ns$)

Characteristics	Complete Took Condition			Ta = 25°C			Ta = -40	Unit	
	Symbol	Test Condition	V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
Output transition time	t _{TLH}		4.5	_	8	15	_	19	ns
Output transition time	t _{THL}	_	5.5	_	7	13	_	16	115
Propagation delay time (CLOCK – Q, Q)	t _{PLH}	_	4.5	_	21	33	_	41	ns
	t _{PHL}		5.5	_	19	30	_	37	
Propagation delay time	t _{PLH}	_	4.5	_	23	35	_	43	ns
$(\overline{CLR}, \overline{PR} - Q, \overline{Q})$	t _{PHL}		5.5	_	20	32	_	40	
Maximum ala ak fraguanay	£		4.5	22	48	_	16	_	MHz
Maximum clock frequency	IMAX	f _{MAX} —	5.5	25	53	_	19	_	IVITZ
Input capacitance	C _{IN}	_		_	5	10	_	10	pF
Power dissipation capacitance	C _{PD}	(Note)			34	_	_	_	pF

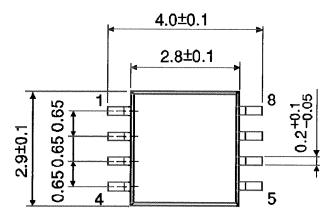
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

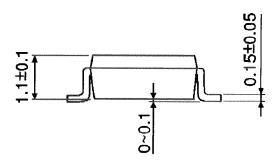
Average operating current can be obtained by the equation:

$$I_{CC\;(opr)} = C_{PD}\;\cdot\;V_{CC}\;\cdot\;f_{IN} + I_{CC}$$

Package Dimensions

SSOP8-P-0.65 Unit: mm





Weight: 0.02 g (typ.)

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